

JAN 23 2007

Patent

Customer No. 31561  
Docket No. 10546-US-PA  
Application No.: 10/709,953

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Applicant : Huang et al.  
 Application No. : 10/709,953  
 Filed : June 9, 2004  
 For : CHIP PACKAGING STRUCTURE HAVING  
       REDISTRIBUTION LAYER WITH RECESS  
 Examiner : WILLIAMS, ALEXANDER O.  
 Art Unit : 2826

TRANSMITTAL LETTER

+1-571-273-8300

(Via fax: 2+7 pages)

Assistant Commissioner for Patents  
Alexandria, VA 22314

Dear Sir,

Pursuant to the Response filed on December 29, 2006 to the Office Action dated November 22, 2006, please find the relevant paper in response thereto as follows:

- Supplemental Amendments in (7) pages.

The Applicant is NOT entitled to a status as a Small Entity; accordingly, please charge the following fees to the Deposit Account No.: 50-2620 (Order No.:10546-US-PA).

Fees are calculated as follows:

 Extra Claims Fee :

	NUMBER FILED	CLAIMS FILED HIGHEST NO. PREVIOUSLY PAID FOR	RATE	Fee
Total Claims	18	MINUS 20 = 0	x \$ 50	= \$ 0
Independent Claims	2	MINUS 3 = 0	x \$ 200	= \$ 0
<input type="checkbox"/> [ ] month(s) extension of time is hereby requested.				= \$ 0
<input type="checkbox"/> Terminal Disclaimer Fee				= \$ 0
<input type="checkbox"/> Fee regarding Submission of an Information Disclosure Statement.				= \$ 0
			Total:	= \$ 0

If the payment is not fully covered in response thereof, the Commissioner is authorized to charge any fees required in connection with the filing of this paper to account No.: 50-2620 (Order No.:10546-US-PA).

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Thank you for your assistance in the subject matter. If you have any questions, please feel free to contact the undersigned.

Respectfully Submitted,  
JIANQ CHYUN Intellectual Property Office

Date: Jan. 22, 2007

By: Belinda Lee  
Belinda Lee  
Registration No.: 46,863

Please send future correspondence to:  
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 HAVING REDISTRIBUTION LAYER)  
 WITH RECESS )

No fee is believed to be due. However, the Commissioner is authorized to charge any fees required in connection with the filing of this paper to account No. 50-2620 (Order No.: 10546-US-PA)

**SUPPLEMENTAL AMENDMENTS**

United States Patent and Trademark Office  
Customer Service Window, Mail Stop Amendment  
Randolph Building  
401 Dulany Street  
Alexandria, VA 22314

Dear Sir:

Pursuant to the Response filed on December 29, 2006 and prior to the examination on merits, please amend the above-identified application as follows and consider the following remarks.